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N-channel 60 V 7.8 mΩ standard level MOSFET

Rev. 03 — 28 October 2010

Product data sheet

1. Product profile

1.1 General description

Standard level N-channel MOSFET in a TO-220 package qualified to 175 °C. This product is designed and qualified for use in a wide range of industrial, communications and domestic equipment.

1.2 Features and benefits

- High efficiency due to low switching and conduction losses
- Suitable for standard level gate drive sources

1.3 Applications

- DC-to-DC converters
- Load switching

- Motor control
- Server power supplies

1.4 Quick reference data

Table 1.	Quick reference data
----------	----------------------

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{DS}	drain-source voltage	T _j ≥ 25 °C; T _j ≤ 175 °C	-	-	60	V
I _D	drain current	$T_{mb} = 25 \text{ °C}; V_{GS} = 10 \text{ V};$ see <u>Figure 1</u>	-	-	92	A
P _{tot}	total power dissipation	T _{mb} = 25 °C; see Figure 2	-	-	149	W
Static cha	racteristics					
R _{DSon}	drain-source on-state resistance	V_{GS} = 10 V; I_D = 25 A; T_j = 25 °C; see <u>Figure 13</u> ; see <u>Figure 9</u>	-	5.9	7.8	mΩ
Dynamic o	characteristics					
Q _{GD}	gate-drain charge	$\label{eq:VGS} \begin{array}{l} V_{GS} = 10 \ V; \ I_D = 25 \ A; \\ V_{DS} = 30 \ V; \ see \ \underline{Figure \ 15}; \\ see \ \underline{Figure \ 14} \end{array}$	-	10.6	-	nC
Avalanche	e ruggedness					
E _{DS(AL)S}	non-repetitive drain-source avalanche energy	$ \begin{array}{l} V_{GS} = 10 \ V; \ T_{j(init)} = 25 \ ^{\circ}C; \\ I_{D} = 92 \ A; \ V_{sup} \leq 100 \ V; \\ R_{GS} = 50 \ \Omega; \ unclamped \end{array} $	-	-	110	mJ



N-channel 60 V 7.8 mΩ standard level MOSFET

2. Pinning information

Table 2.	Pinning	information		
Pin	Symbol	Description	Simplified outline	Graphic symbol
1	G	gate		_
2	D	drain	mb	
3	S	source		
mb	D	mounting base; connected to drain		mbb076 S
			SOT78 (TO-220AB)	

3. Ordering information

Table 3. Ordering information

Type number	Package		
	Name	Description	Version
PSMN7R6-60PS	TO-220AB	plastic single-ended package; heatsink mounted; 1 mounting hole; 3-lead TO-220AB	SOT78

4. Limiting values

Table 4.Limiting values

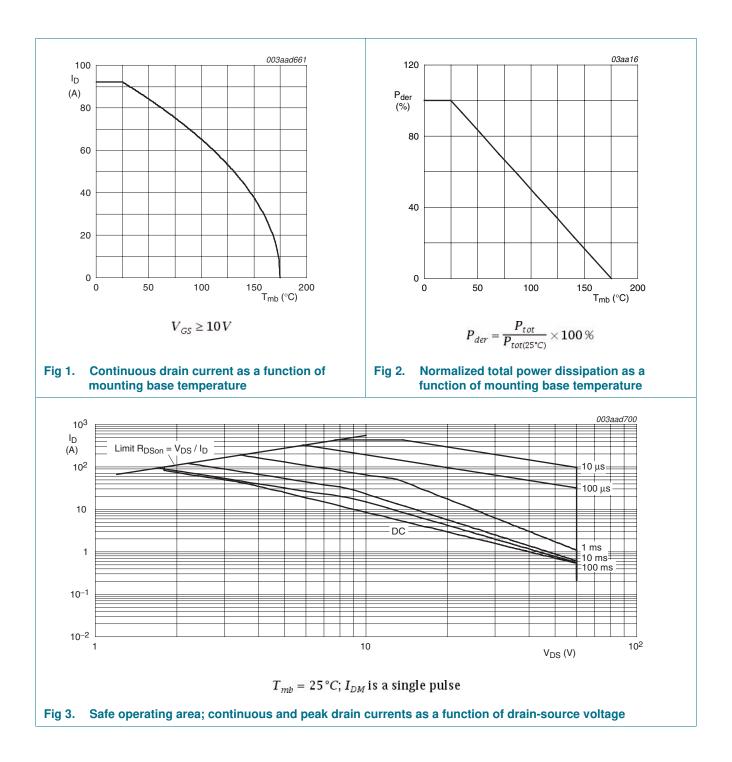
In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V _{DS}	drain-source voltage	T _j ≥ 25 °C; T _j ≤ 175 °C	-	60	V
V _{DGR}	drain-gate voltage	$R_{GS} = 20 \text{ k}\Omega$	-	60	V
V _{GS}	gate-source voltage		-20	20	V
I _D	drain current	V_{GS} = 10 V; T_{mb} = 100 °C; see <u>Figure 1</u>	-	65	А
		$V_{GS} = 10 \text{ V}; \text{ T}_{mb} = 25 \text{ °C}; \text{ see } \frac{\text{Figure 1}}{10000000000000000000000000000000000$	-	92	А
I _{DM}	peak drain current	pulsed; $t_p \le 10 \ \mu s$; $T_{mb} = 25 \ ^{\circ}C$; see Figure 3	-	389	Α
P _{tot}	total power dissipation	T _{mb} = 25 °C; see <u>Figure 2</u>	-	149	W
T _{stg}	storage temperature		-55	175	°C
Tj	junction temperature		-55	175	°C
Source-drai	in diode				
I _S	source current	T _{mb} = 25 °C	-	92	Α
I _{SM}	peak source current	pulsed; $t_p \le 10 \ \mu s$; $T_{mb} = 25 \ ^{\circ}C$	-	389	Α
Avalanche i	ruggedness				
E _{DS(AL)S}	non-repetitive drain-source avalanche energy	$V_{GS} = 10 \text{ V}; \text{ T}_{j(init)} = 25 \text{ °C}; \text{ I}_{D} = 92 \text{ A};$ $V_{sup} \leq 100 \text{ V}; \text{ R}_{GS} = 50 \Omega; \text{ unclamped}$	-	110	mJ

PSMN7R6-60PS	
Product data sheet	

PSMN7R6-60PS

N-channel 60 V 7.8 mΩ standard level MOSFET



tp

т

1 1 1 1

1

δ =

N-channel 60 V 7.8 mΩ standard level MOSFET

Р

10⁻¹

tp

t_p (s)

5. Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$R_{th(j-mb)}$	thermal resistance from junction to mounting base	see Figure 4	-	0.49	1.01	K/W
1 Z _{th} (K/W)	δ = 0.5			00	3aad662	

10⁻³

Fig 4. Transient thermal impedance from junction to mounting base as a function of pulse duration

Ħ

10⁻⁴

10⁻²

Table 5. Thermal characteristics

0.2

-0.1

0.02

0.05

single shot

10⁻⁵

10-1

10⁻²

10⁻³

10⁻⁶

PSMN7R6-60PS
Product data sheet

N-channel 60 V 7.8 mΩ standard level MOSFET

6. Characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static chara	cteristics					
V _{(BR)DSS}	drain-source breakdown voltage	$I_D = 250 \ \mu A; V_{GS} = 0 \ V; T_j = -55 \ ^{\circ}C$	54	-	-	V
		$I_D = 250 \ \mu\text{A}; \ V_{GS} = 0 \ V; \ T_j = 25 \ ^\circ\text{C}$	60	-	-	V
V _{GS(th)}	gate-source threshold voltage	$I_D = 1 \text{ mA}; V_{DS} = V_{GS}; T_j = 25 \text{ °C};$ see <u>Figure 10</u> ; see <u>Figure 11</u>	2	3	4	V
V _{GSth}	gate-source threshold voltage	$I_D = 1 \text{ mA}; V_{DS} = V_{GS}; T_j = 175 \text{ °C};$ see <u>Figure 11</u>	1	-	-	V
		$I_D = 1 \text{ mA}; V_{DS} = V_{GS}; T_j = -55 \text{ °C};$ see <u>Figure 11</u>	-	-	4.6	V
I _{DSS}	drain leakage current	$V_{DS} = 60 \text{ V}; V_{GS} = 0 \text{ V}; T_j = 25 \text{ °C}$	-	0.05	10	μA
		$V_{DS} = 60 \text{ V}; V_{GS} = 0 \text{ V}; T_j = 125 \text{ °C}$	-	-	100	μA
I _{GSS}	gate leakage current	$V_{GS} = 20 \text{ V}; V_{DS} = 0 \text{ V}; T_j = 25 \text{ °C}$	-	2	100	nA
		V_{GS} = -20 V; V_{DS} = 0 V; T_j = 25 °C	-	2	100	nA
R _{DSon}	drain-source on-state resistance	V_{GS} = 10 V; I _D = 25 A; T _j = 175 °C; see <u>Figure 12</u>	-	13.3	18	mΩ
		$V_{GS} = 10 \text{ V}; I_D = 25 \text{ A}; T_j = 25 \text{ °C};$ see Figure 13; see Figure 9	-	5.9	7.8	mΩ
R _G	gate resistance	f = 1 MHz	-	0.98	-	Ω
Dynamic cha	aracteristics					
Q _{G(tot)}	total gate charge	$I_D = 25 \text{ A}; V_{DS} = 30 \text{ V}; V_{GS} = 10 \text{ V};$	-	38.7	-	nC
Q _{GS}	gate-source charge	see Figure 14; see Figure 15	-	12.9	-	nC
Q _{GS(th)}	pre-threshold gate-source charge		-	6.9	-	nC
Q _{GS(th-pl)}	post-threshold gate-source charge		-	6	-	nC
Q _{GD}	gate-drain charge	$I_D = 25 \text{ A}; V_{DS} = 30 \text{ V}; V_{GS} = 10 \text{ V};$ see <u>Figure 15</u> ; see <u>Figure 14</u>	-	10.6	-	nC
V _{GS(pl)}	gate-source plateau voltage	$I_D = 25 \text{ A}; V_{DS} = 30 \text{ V}; \text{ see } \frac{\text{Figure}}{14}; \text{ see } \frac{\text{Figure } 15}{15}$	-	5.6	-	V
C _{iss}	input capacitance	$V_{DS} = 30 \text{ V}; V_{GS} = 0 \text{ V}; f = 1 \text{ MHz};$ $T_j = 25 \text{ °C}; \text{ see } \frac{\text{Figure 16}}{\text{Figure 8}}; \text{ see}$	-	2651	-	pF
C _{oss}	output capacitance	$\label{eq:VDS} \begin{array}{l} V_{DS} = 30 \text{ V}; V_{GS} = 0 \text{ V}; \text{f} = 1 \text{ MHz}; \\ T_{j} = 25 \text{ °C}; \text{ see } \underline{\text{Figure 16}} \end{array}$	-	342	-	pF
C _{rss}	reverse transfer capacitance	$V_{DS} = 30 \text{ V}; V_{GS} = 0 \text{ V}; f = 1 \text{ MHz};$ $T_j = 25 \text{ °C}; \text{ see } \frac{\text{Figure 16}}{\text{Figure 8}}; \text{ see}$	-	183	-	pF
t _{d(on)}	turn-on delay time	$V_{DS} = 30 \; V; \; R_L = 1.2 \; \Omega; \; V_{GS} = 10 \; V; \;$	-	19	-	ns
t _r	rise time	$R_{G(ext)} = 4.7 \Omega$	-	21	-	ns
t _{d(off)}	turn-off delay time		-	37	-	ns
t _f	fall time		-	13	-	ns

PSMN7R6-60PS Product data sheet

PSMN7R6-60PS

Тур

Unit

Max

N-channel 60 V 7.8 mΩ standard level MOSFET

Min

Source-drain d	diode			- 71		
/ _{SD}	source-drain voltage	I _S = 25 A; V _{GS} = 0 V; T _j = 25 °C; see <u>Figure 17</u>	-	0.86	1.2	V
r	reverse recovery time	I _S = 25 A; dI _S /dt = 100 A/μs;	-	40.4	-	ns
Q _r	recovered charge	$V_{GS} = 0 V; V_{DS} = 30 V$	-	56	-	nC
	003aad 15 6.0 5.5 8.0 5.0 5.0 $V_{GS}(V) = 4.5$ 0.5 1 1.5 $V_{DS}(V)$ $T_j = 25 °C; t_p = 300 \ \mu s$ ut characteristics: drain current ion of drain-source voltage; typ	$\begin{array}{c} 160 \\ g_{\text{fs}} \\ (S) \\ 120 \\ & \\ 80 \\ & \\ 40 \\ & \\ 0 \\ & \\ 0 \\ & \\ 20 \end{array}$		80	03aad669	n of
100 I _D (A) 80 60 40 20 0 0	$\begin{array}{c} 003aadt\\ \hline \\ \\ \hline \\ \\ \hline \\$	365 4000 C C (pF) 3000 2000 C 1000 0	10		203aad664	
	$V_{DS} = 25 \text{ V}$	$V_{DS} =$	0 V; f = 1			
	sfer characteristics: drain curre ion of gate-source voltage; typi					

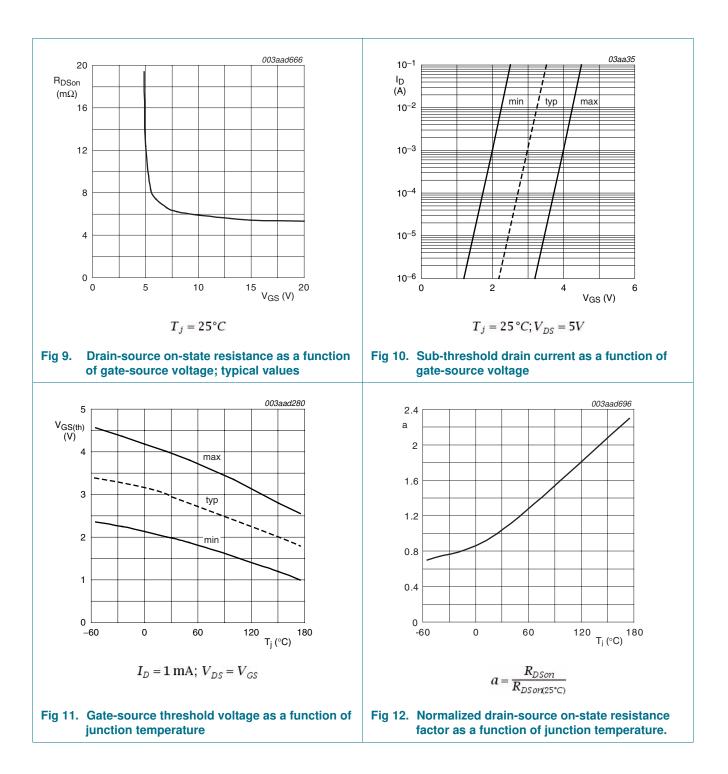
Conditions

Characteristics ... continued

Table 6.

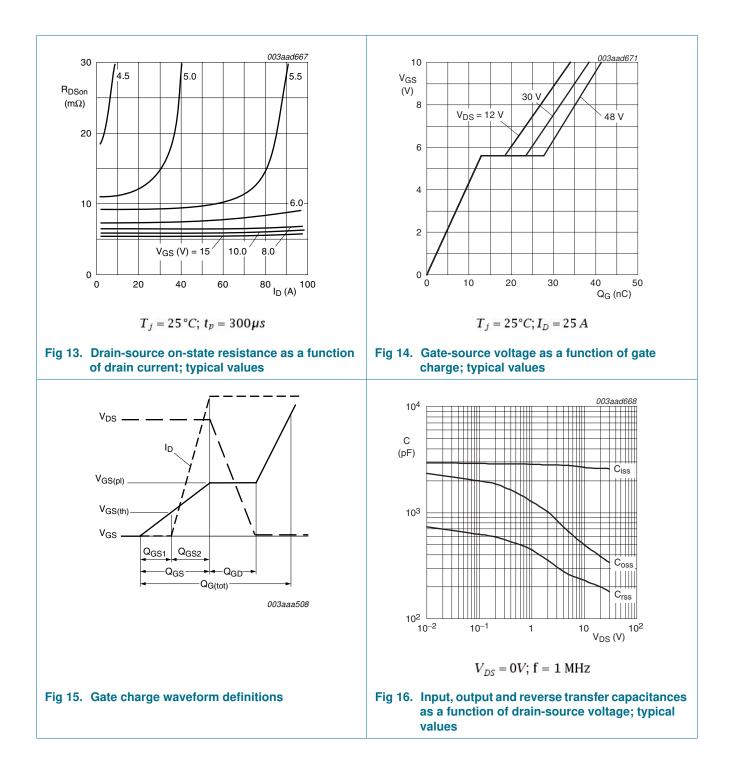
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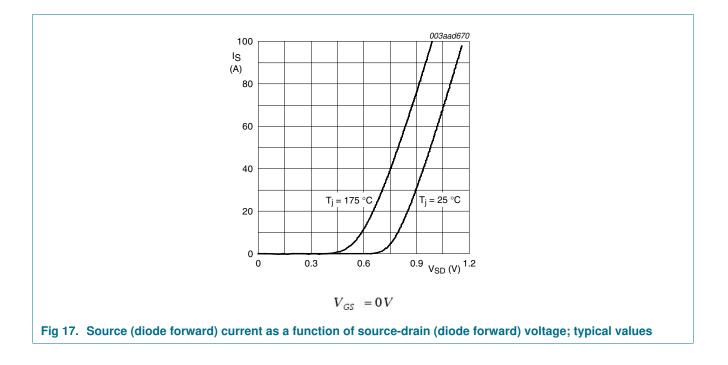
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Package outline 7.

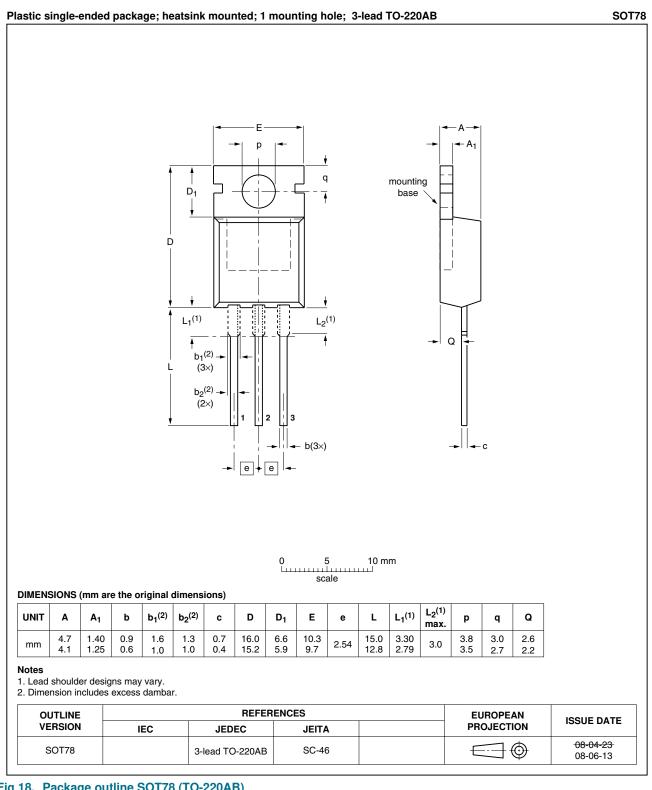


Fig 18. Package outline SOT78 (TO-220AB)

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8. Revision history

Table 7.Revision h	nistory			
Document ID	Release date	Data sheet status	Change notice	Supersedes
PSMN7R6-60PS v.3	20101028	Product data sheet	-	PSMN7R6-60PS v.2
Modifications:	 Various chang 	es to content.		
PSMN7R6-60PS v.2	20100122	Product data sheet	-	-

N-channel 60 V 7.8 mΩ standard level MOSFET

9. Legal information

9.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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